



15A SBR[®] SUPER BARRIER RECTIFIER POWERDI[®]5

Product Summary (@ T_A = +25°C)

	V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C
I	30	15	0.59	0.1

Description

Packaged in the compact thermally efficient POWERDI5 package, the SBR15A30SP5 provides very low V_F and excellent reverse leakage stability at high temperatures. It is ideal for use as a rectification, freewheeling or polarity protection diode.

Applications

- Solar Panels
- **DC-DC** Converters
- AC-DC Adaptors



POWERDI5

Top View

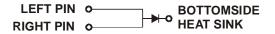
Bottom View

Features and Benefits

- Low forward voltage drop (V_F) helps minimize power losses
- Excellent stability at higher temperatures
- Thermally efficient package for cooler running applications
- Less than 1.1mm package profile ideal for thin applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI5
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.093 grams (approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information

Part Number		Case	Packaging		
	SBR15A30SP5-13	POWERDI5	5000/Tape & Reel		
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.					

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Marking Information



S15A30S = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 14 = 2014) K = Factory Designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM}	30	V
Average Rectified Output Current	lo	15	A
Non-Repetitive Peak Forward Surge Current 8.3mS	I _{FSM}	136	А
Non-Repetitive Avalanche Energy ($T_J = +25^{\circ}C$, $I_{AS} = 10A$, L = 10mH)	E _{AS}	460	mJ
Repetitive Peak Avalanche Energy (1µs, +25°C)	PARM	2700	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 4)) R _{0JA}	100	°C/W
Typical Thermal Resistance Junction to Case (Notes 4, 6	6) R _{0JC}	25	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)) R _{0JA}	20	°C/W
Typical Thermal Resistance Junction to Case (Notes 5, 6	6) R _{0JC}	3	°C/W
Operating Temperature Range VR ≤ 80% VRR VR ≤ 50% VRR DC Forward Mode (Note	RM TJ	-65 to +150 ≤180 ≤200	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF		0.42 0.38 0.54 0.51	0.52 0.59 	V	$I_{F} = 7.5A, T_{J} = +25^{\circ}C$ $I_{F} = 7.5A, T_{J} = +125^{\circ}C$ $I_{F} = 15A, T_{J} = +25^{\circ}C$ $I_{F} = 15A, T_{J} = +125^{\circ}C$
Leakage Current (Note 6)	I _R	_	0.03 13	0.1	mA	$V_R = 30V$, $T_J = +25^{\circ}C$ $V_R = 30V$, $T_J = +125^{\circ}C$
Junction Capacitance	CT	_	300	_	pF	V _R = 15V , T _J = +25°C

Notes: 4. Device mounted on FR4 PCB with minimum recommended pad layout per http://www.diodes.com.

5. Device mounted on FR4 PCB with 1inch pad layout and additional HK2 (45mm x 20mm x12mm).

6. Short duration pulse test used to minimize self-heating effect.

7. Max junction temperature guaranteed for 2 hours.

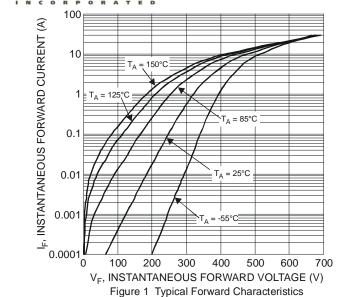


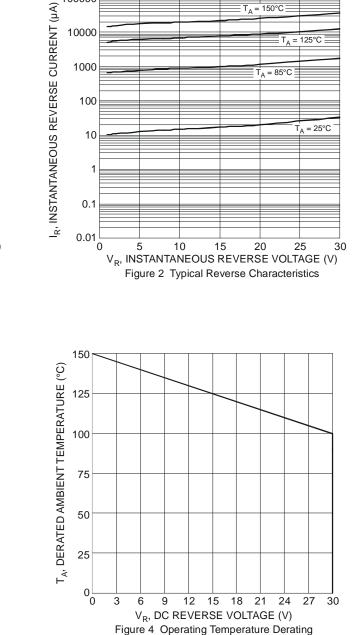
SBR15A30SP5

 $T_A = 125^{\circ}C$

T_A = 150°C

Т_А = 85°С



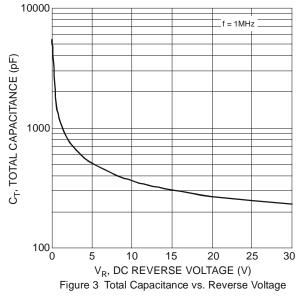


100000

10000

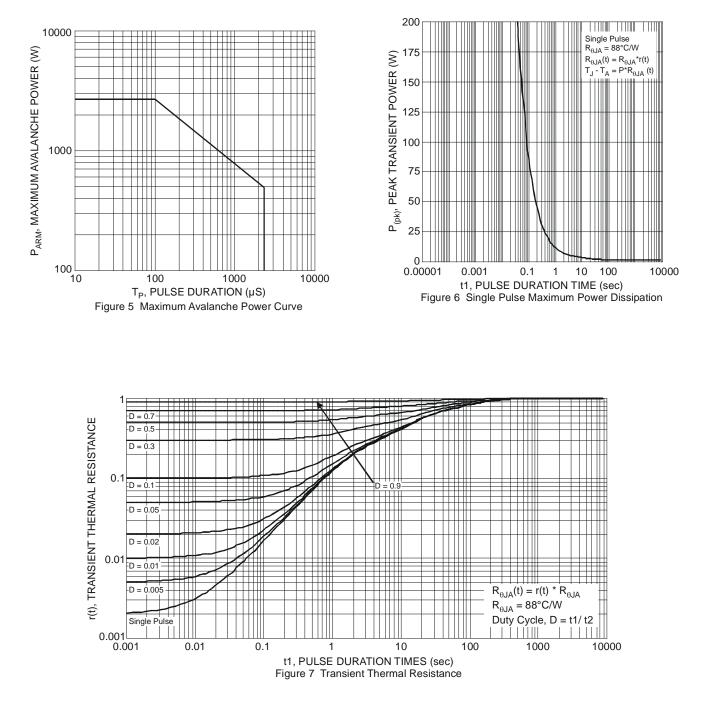
1000

100





SBR15A30SP5





Max

1.15

0.43

0.99

1.88

4.05

6.60

5.45

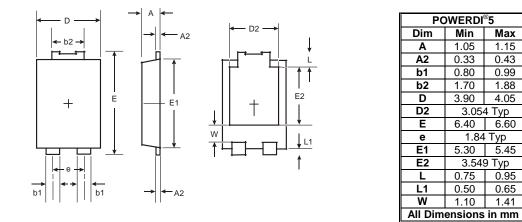
0.95

0.65

1.41

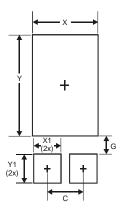
Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1.400



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